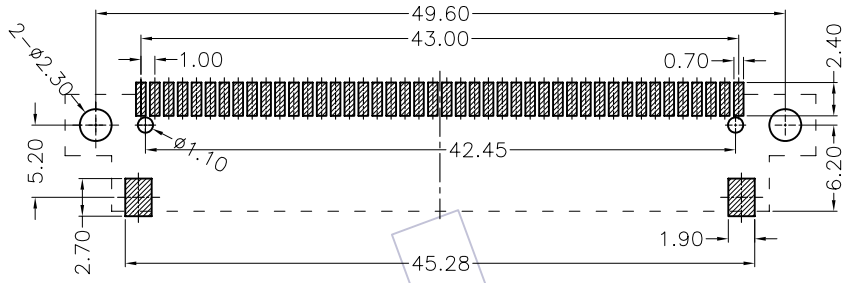
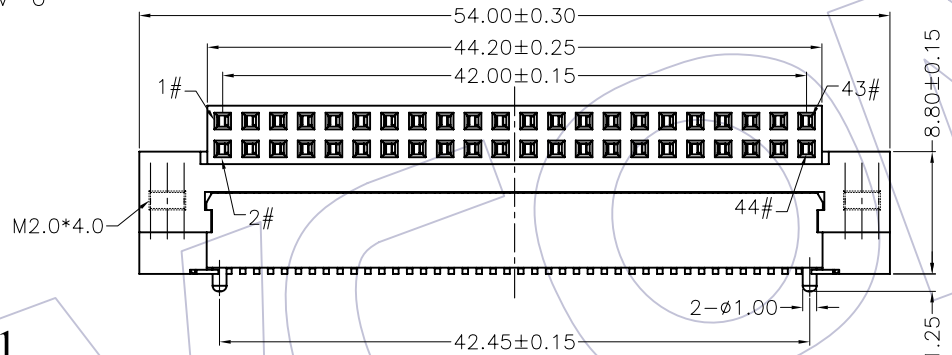
HSF

TECHNICAL SPECS:
Current Rating: 2.0AMP
Withstand Voltage: 500V AC/Minute
Contact Resistance: 30mΩ Max
Insulation Resistance: 1000MΩ Min
Operation Temperature: −40℃ to +105℃

Contact Material:Phosphor Bronze,Nut:Brass
Contact plating:Au or Sn over Ni
Insulator Material:LCP/PA6T+30%G.F UL94V−0

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

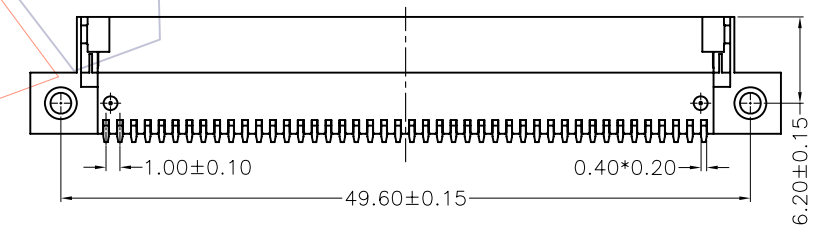


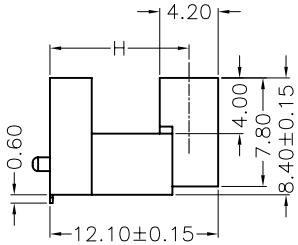


Ordering Information

22B- XXX 44 M XX X N X 1

- XXX — The Distance of Connector center to the P.C.B
  - 075:H=7.50mm
  - 081:H=8.10mm
  - 086:H=8.60mm
  - 100:H=10.0mm
- XX — Contact Plating
  - G0=Gold Flash
  - G1=3u"Gold
  - G2=5u"Gold
  - G3=10u"Gold
  - G4=15u"Gold
  - G5=30u"Gold
  - S0=Gold Flash/Tin
  - S1=3u"Gold/Tin
  - S2=5u"Gold/Tin
  - S3=10u"Gold/Tin
  - S4=15u"Gold/Tin
  - S5=30u"Gold/Tin
  - SN=Tin
- X — Insulator Material
  - C=PA6T
  - D=LCP
- X — Packing
  - A=Tray
  - T=Tube





REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE
A0	09/01/03	NEW	———	———

OPERATION		DRAW	WEIXD	09/01/03
X.X	±0.40	DESIGN		
X.XX	±0.25			
X.XXX	±0.15	CHECK		
Angle	± 3°	APPROVE		
DIM	TOL			

SCALE	1:1	WCON 维峰五金电子有限公司 WAFE HARDWARE ELECTRONICS CO.LTD	
UNIT	mm		
SIZE	A4	PART NO.	22B-XXX44MXXXNX1
SHEET	1/1	TITLE:	2.00mm HDD SOCKET SMT TYPE
PROJ.		Customer NO.	